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Renesas Technology Corp.
Customer Support Dept.
April 1, 2003

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HD74AC670

4×4 Register File with 3-State Output



ADE-205-399 (Z)
1st. Edition
Sep. 2000

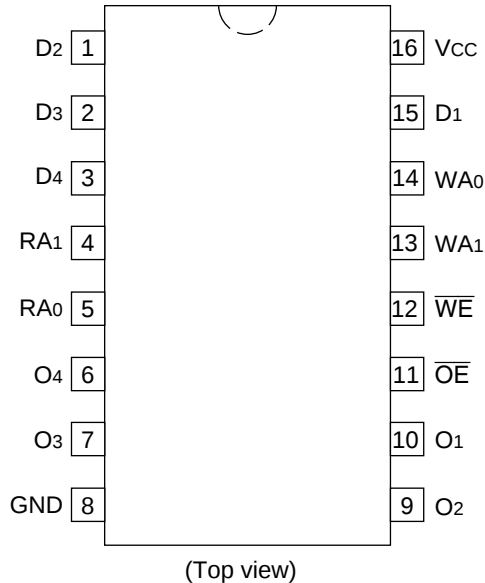
Description

The HD74AC670 contains 16 high speed, low power, transparent D-type latches arranged as four words of four bits each, to function as a 4×4 register file. Separate read and write inputs, both address and enable, allow simultaneous read and write operation. The 3-state outputs make it possible to connect up to 128 outputs to increase the word capacity up to 512 words. Any number of these devices can be operated in parallel to generate an n-bit length.

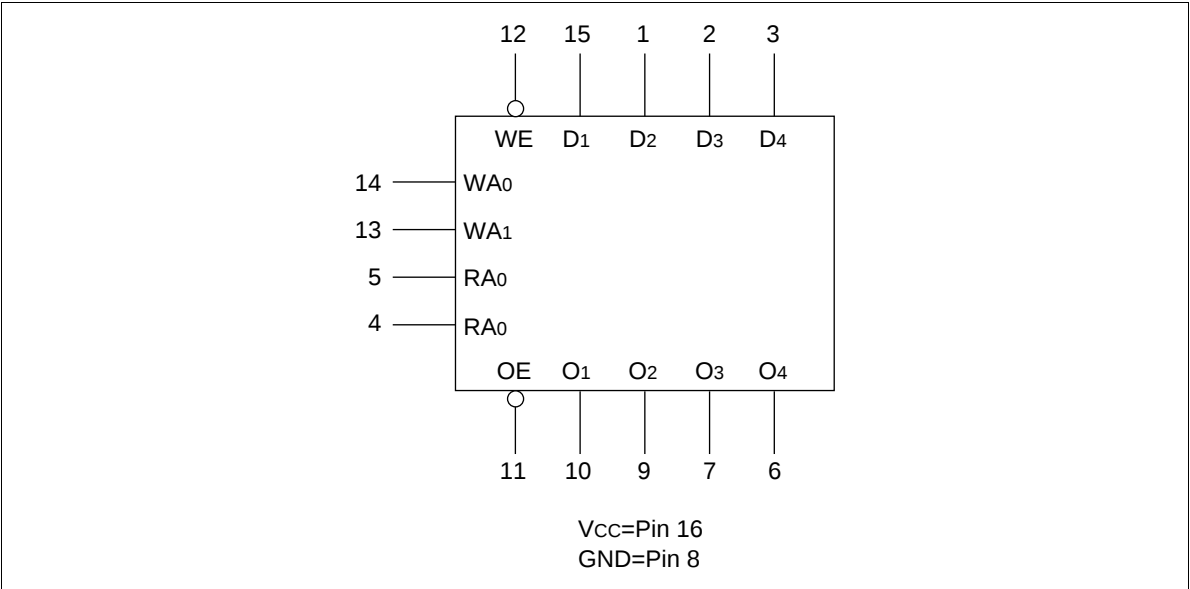
Features

- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- Outputs Source/Sink 24 mA

Pin Arrangement



Logic Symbol



Pin Names

- D₁ to D₄ : Data Inputs
- WA₀, WA₁ : Write Address Inputs
- WE : Write Enable Input (Active Low)
- RA₀, RA₁ : Read Address Inputs
- OE : 3-State Output Enable Input (Active Low)
- O₁ to O₄ : Data Outputs

Write Function Table

Write Inputs			
WE	WA ₁	WA ₀	D Inputs to
L	L	L	Word 0
L	L	H	Word 1
L	H	L	Word 2
L	H	H	Word 3
H	X	X	None (hold)

- H : High Voltage Level
- L : Low Voltage Level
- X : Immaterial

Read Function Table

Read Inputs

$\overline{\text{OE}}$	RA_1	RA_0	Outputs from
L	L	L	Word 0
L	L	H	Word 1
L	H	L	Word 2
L	H	H	Word 3
H	X	X	None (HIGH Z)

H : High Voltage Level

L : Low Voltage Level

X : Immaterial

AC Characteristics: HD74AC670

Item	Symbol	V _{CC} (V)*1	Ta = +25°C C _L = 50 pF			Ta = -40°C to +85°C C _L = 50 pF		Unit
			Min	Typ	Max	Min	Max	
Propagation delay	t _{PLH}	3.3	1.0	14.0	17.5	1.0	19.0	ns
$\overline{W}_E$ to O _n		5.0	1.0	11.5	13.5	1.0	15.0	
Propagation delay	t _{PHL}	3.3	1.0	13.5	17.0	1.0	18.5	ns
$\overline{W}_E$ to O _n		5.0	1.0	11.0	13.0	1.0	14.5	
Propagation delay	t _{PLH}	3.3	1.0	12.5	15.5	1.0	17.0	ns
R _{A1} or R _{A0} to O _n		5.0	1.0	10.0	12.0	1.0	13.0	
Propagation delay	t _{PHL}	3.3	1.0	12.5	15.5	1.0	17.0	ns
R _{A1} or R _{A0} to O _n		5.0	1.0	10.0	12.0	1.0	13.0	
Propagation delay	t _{PLH}	3.3	1.0	12.0	15.0	1.0	16.5	ns
Data to O _n		5.0	1.0	9.5	11.5	1.0	12.5	
Propagation delay	t _{PHL}	3.3	1.0	11.5	14.5	1.0	16.0	ns
Data to O _n		5.0	1.0	9.0	11.0	1.0	12.0	
Enable time	t _{ZH}	3.3	1.0	8.0	11.0	1.0	12.0	ns
$\overline{OE}$ to O _n		5.0	1.0	6.0	8.5	1.0	9.5	
Enable time	t _{ZL}	3.3	1.0	10.0	12.0	1.0	13.0	ns
$\overline{OE}$ to O _n		5.0	1.0	7.5	9.5	1.0	10.5	
Disable time	t _{HZ}	3.3	1.0	8.0	11.0	1.0	12.0	ns
$\overline{OE}$ to O _n		5.0	1.0	6.0	8.5	1.0	9.5	
Disable time	t _{LZ}	3.3	1.0	9.0	11.5	1.0	12.5	ns
$\overline{OE}$ to O _n		5.0	1.0	7.0	9.0	1.0	10.0	

Note: 1. Voltage Range 3.3 is 3.3 V ± 0.3 V
Voltage Range 5.0 is 5.0 V ± 0.5 V

HD74AC670

AC Operating Requirements: HD74AC670

			Ta = +25°C C _L = 50 pF	Ta = −40°C to +85°C C _L = 50 pF		
Item	Symbol	V _{CC} (V)*1	Typ	Guaranteed Minimum		Unit
Setup time	t _{su}	3.3	3.0	5.5	6.0	ns
Data to $\overline{W}_E$		5.0	2.0	4.5	4.5	
Setup time		3.3	3.0	5.5	6.0	ns
W _{A1} or W _{A0} to $\overline{W}_E$		5.0	2.0	4.5	4.5	
Hold time	t _h	3.3	3.0	4.0	4.0	ns
$\overline{W}_E$ to Data		5.0	2.5	4.0	4.0	
Hold time		3.3	3.0	4.0	4.0	ns
$\overline{W}_E$ to W _{A1} or W _{A2}		5.0	2.5	4.0	4.0	
Pulse width	t _w	3.3	3.5	5.5	7.0	ns
$\overline{W}_E$		5.0	2.5	4.5	5.0	
Latch width	t _{latch}	3.3	0.5	10.0	10.0	ns
$\overline{W}_E$ to 1		5.0	0.5	10.0	10.0	

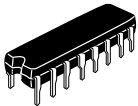
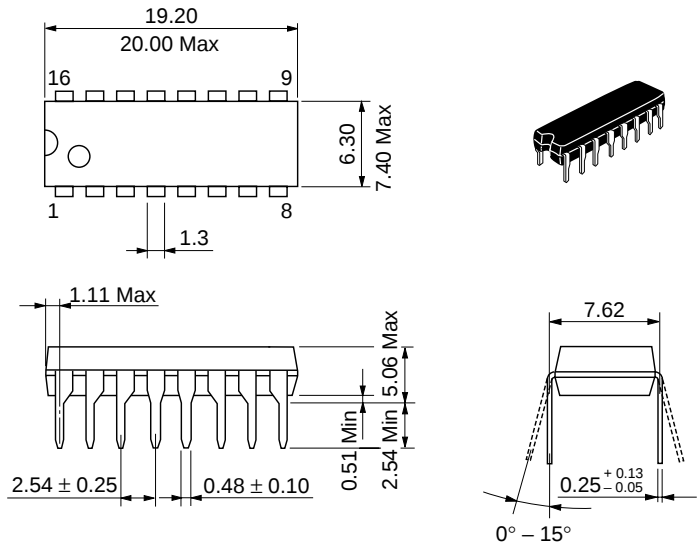
Note: 1. Voltage Range 3.3 is 3.3 V ± 0.3 V
Voltage Range 5.0 is 5.0 V ± 0.5 V

Capacitance

Item	Symbol	Typ	Unit	Condition
Input capacitance	C _{IN}	4.5	pF	V _{CC} = 5.5 V
Power dissipation capacitance	C _{PD}	60	pF	V _{CC} = 5.0 V

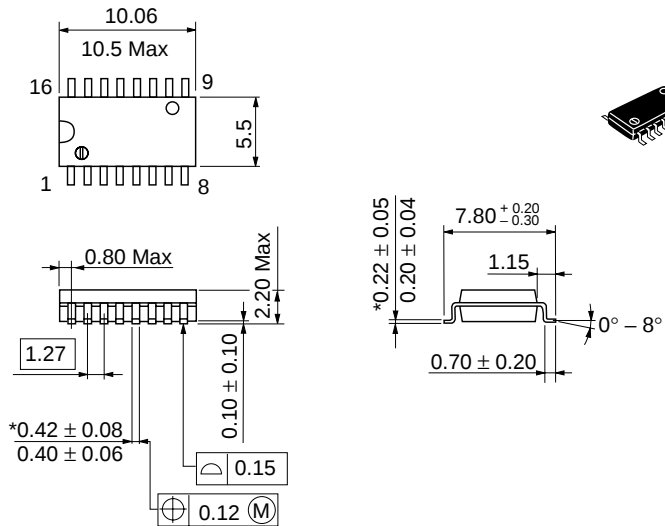
Package Dimensions

Unit: mm



Hitachi Code	DP-16
JEDEC	Conforms
EIAJ	Conforms
Mass (reference value)	1.07 g

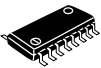
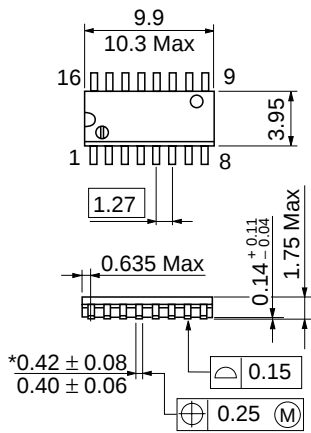
Unit: mm



*Dimension including the plating thickness
Base material dimension

Hitachi Code	FP-16DA
JEDEC	—
EIAJ	Conforms
Mass (reference value)	0.24 g

Unit: mm



*Dimension including the plating thickness
Base material dimension

Hitachi Code	FP-16DN
JEDEC	Conforms
EIAJ	Conforms
Mass (reference value)	0.15 g

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HITACHI

Hitachi, Ltd.

Semiconductor & Integrated Circuits.

Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

URL	NorthAmerica	:	http://semiconductor.hitachi.com/
	Europe	:	http://www.hitachi-eu.com/hel/ecg
	Asia	:	http://sicapac.hitachi-asia.com
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For further information write to:

Hitachi Semiconductor
(America) Inc.

179 East Tasman Drive,
San Jose, CA 95134

Tel: <1> (408) 433-1990

Fax: <1> (408) 433-0223

Hitachi Europe GmbH
Electronic Components Group

Dornacher Straße 3
D-85622 Feldkirchen, Munich

Germany

Tel: <49> (89) 9 9180-0

Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd.

Electronic Components Group.

Whitebrook Park

Lower Cookham Road

Maidenhead

Berkshire SL6 8YA, United Kingdom

Tel: <44> (1628) 585000

Fax: <44> (1628) 585160

Hitachi Asia Ltd.

Hitachi Tower

16 Collyer Quay #20-00,

Singapore 049318

Tel: <65>-538-6533/538-8577

Fax: <65>-538-6933/538-3877

URL: <http://www.hitachi.com.sg>

Hitachi Asia Ltd.

(Taipei Branch Office)

4/F, No. 167, Tun Hwa North Road,

Hung-Kuo Building,

Taipei (105), Taiwan

Tel: <886>-(2)-2718-3666

Fax: <886>-(2)-2718-8180

Telex: 23222 HAS-TP

URL: <http://www.hitachi.com.tw>

Hitachi Asia (Hong Kong) Ltd.

Group III (Electronic Components)

7/F., North Tower,

World Finance Centre,

Harbour City, Canton Road

Tsim Sha Tsui, Kowloon,

Hong Kong

Tel: <852>-(2)-735-9218

Fax: <852>-(2)-730-0281

URL: <http://www.hitachi.com.hk>